

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any lange of the applicatio customer's to unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the



FQD3P50 P-Channel QFET[®] MOSFET - 500 V, - 2.1 A, 4.9 Ω

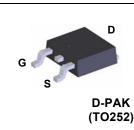
Description

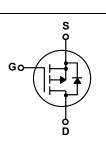
This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor[®]'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

May 2015

Features

- 2.1 A, 500 V, ${\sf R}_{\sf DS(on)}$ = 4.9 Ω (Max.) @ ${\sf V}_{\sf GS}$ = 10 V, ID = 1.05 A
- Low Gate Charge (Typ. 18 nC)
- Low Crss (Typ. 9.5 pF)
- 100% Avalanche Tested





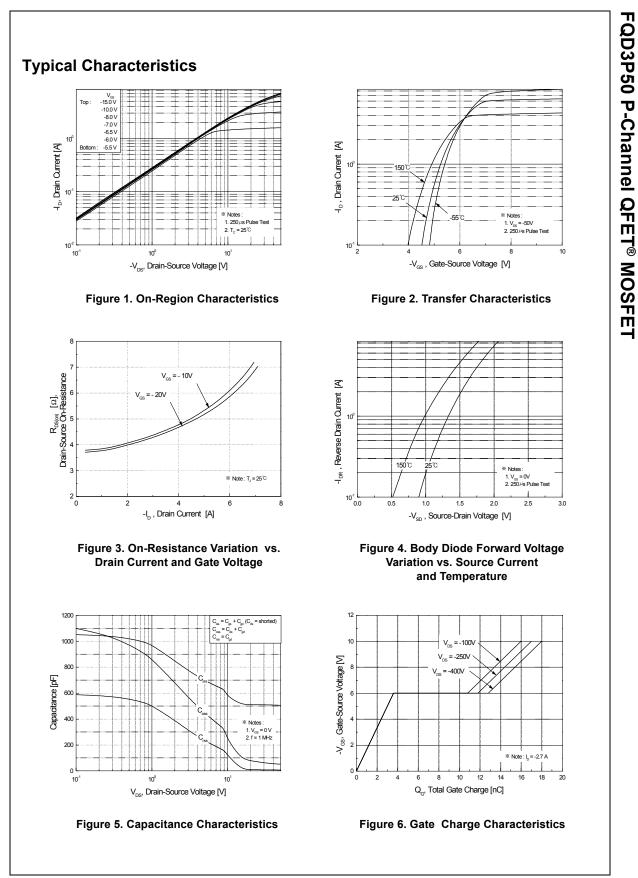
Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Symbol	Parameter		FQD3P50	Unit
V _{DSS}	Drain-Source Voltage		-500	V
ID	Drain Current - Continuous (T _C = 25°C)		-2.1	Α
	- Continuous (T _C = 10	0°C)	-1.33	А
I _{DM}	Drain Current - Pulsed	(Note 1)	-8.4	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	250	mJ
I _{AR}	Avalanche Current	(Note 1)	-2.1	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.0	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-4.5	V/ns
P _D	Power Dissipation (T _A = 25°C) *		2.5	W
	Power Dissipation (T _C = 25°C)		50	W
	- Derate above 25°C		0.4	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

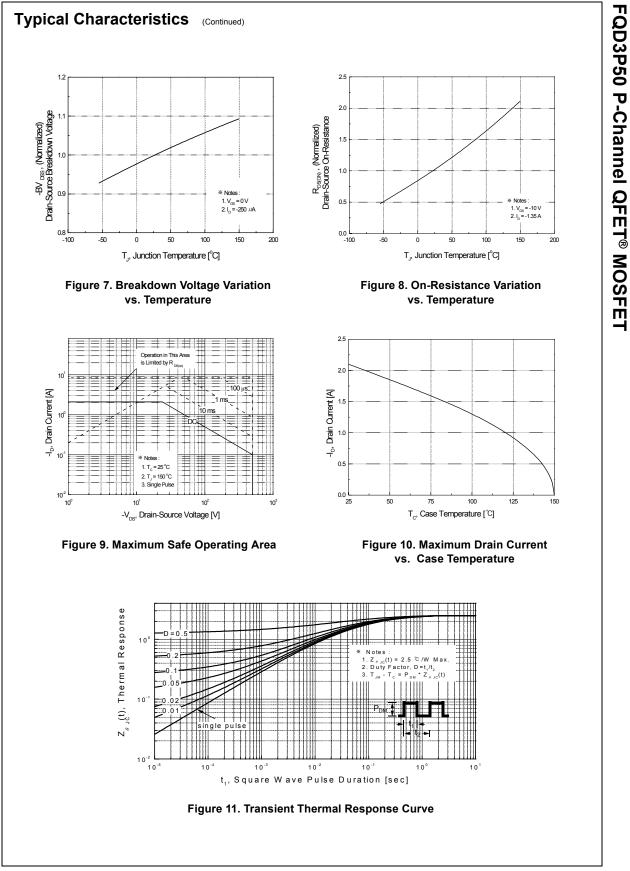
Symbol	Parameter	FQD3P50	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max. *	50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	110	°C/W

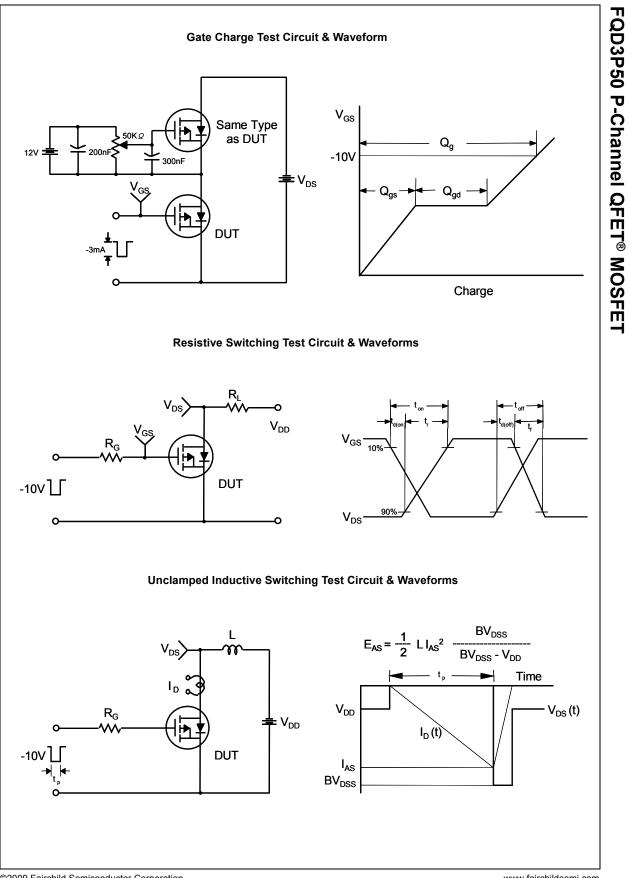
	Parameter	Test Conditions	Min	Тур	Мах	Unit
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA				V
ΔBV _{DSS}	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		0.42		V/°C
I _{DSS}		V _{DS} = -500 V, V _{GS} = 0 V			-1	μA
	Zero Gate Voltage Drain Current $V_{DS} = -400 \text{ V}, T_C = 125^{\circ}\text{C}$				-10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = -30 V, V_{DS} = 0 V			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_{D} = -250 \ \mu A$	-3.0		-5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -1.05 A		3.9	4.9	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -50 V, I _D = -1.05 A		2.1		S
D						
Dynami C _{iss}	ic Characteristics Input Capacitance			510	660	pF
C _{oss}	Output Capacitance	$V_{DS} = -25 V, V_{GS} = 0 V,$		70	90	pF
C _{rss}	Reverse Transfer Capacitance	f = 1.0 MHz		9.5	12	pF
d(on)	Turn-On Delay Time Turn-On Rise Time	V_{DD} = -250 V, I _D = -2.7 A, R _G = 25 Ω		12 56	35 120	ns ns
u(011) t _r						
t _{d(off)}	Turn-Off Delay Time			35	80	ns
t _f	Turn-Off Fall Time	(Note 4)		45	100	ns
Qg	Total Gate Charge	V _{DS} = -400 V, I _D = -2.7 A,		18	23	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -10 V		3.6		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		9.2		nC
Drain-S	ource Diode Characteristics an Maximum Continuous Drain-Source Dio	•			-2.1	A
	Maximum Pulsed Drain-Source Diode F	Diode Forward Current			-8.4	Α
I _{SM}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -2.1 A			-5.0	V
I _{SM} V _{SD}	Dialit-Source Dioue Forward Voltage	00 - 70				
	Reverse Recovery Time	$V_{GS} = 0 V, I_S = -2.7 A,$		270		ns



©2009 Fairchild Semiconductor Corporation FQD3P50 Rev. 1.2

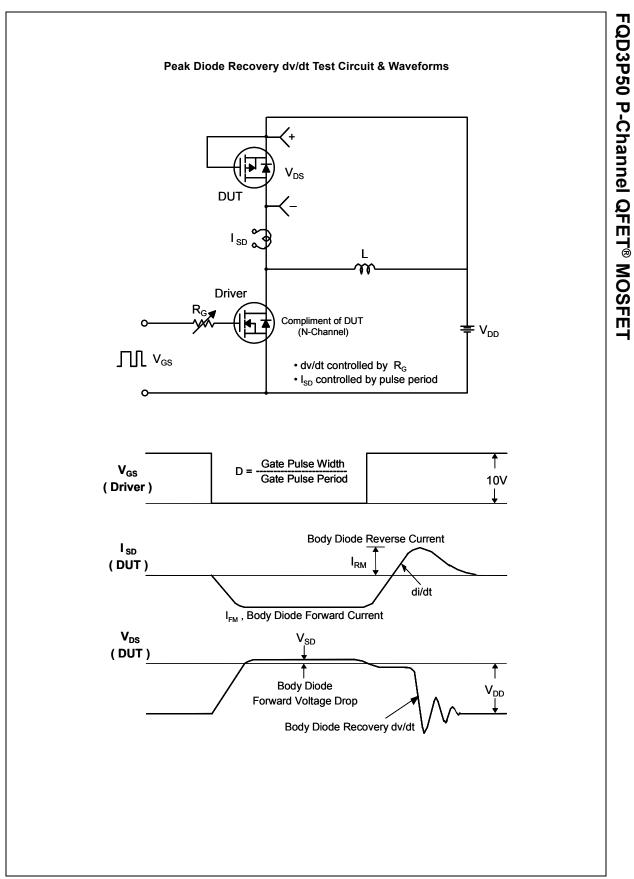
www.fairchildsemi.com

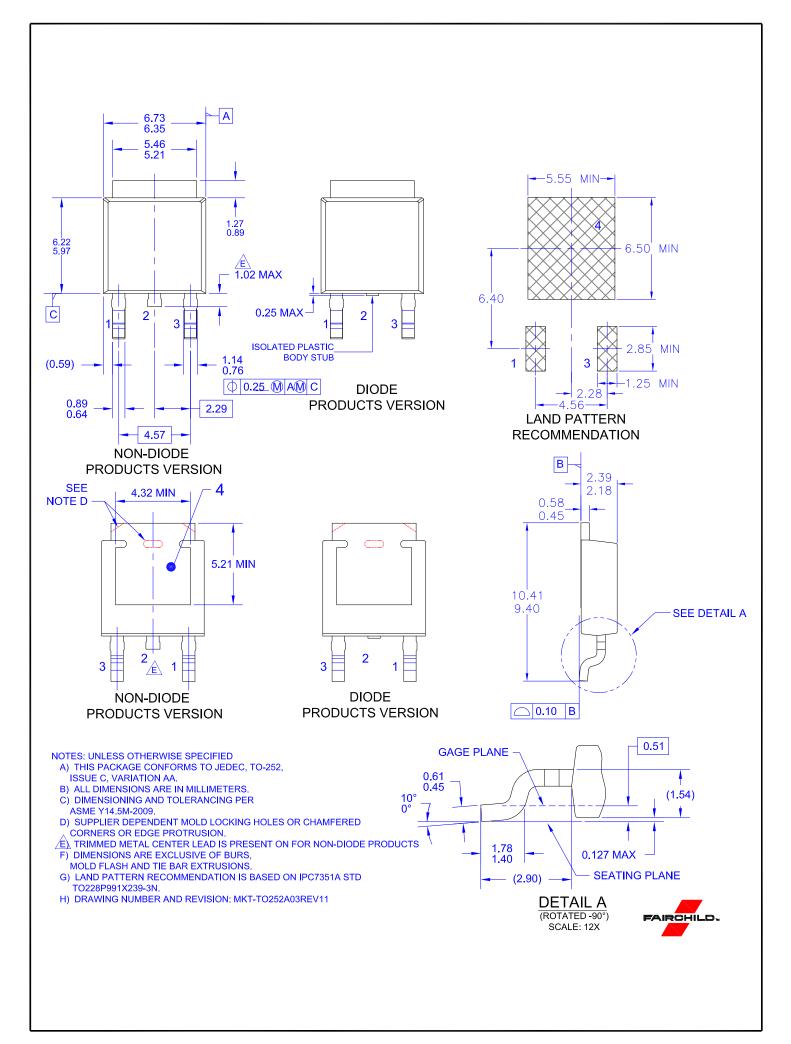




©2009 Fairchild Semiconductor Corporation FQD3P50 Rev. 1.2

www.fairchildsemi.com





ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC